

# The cooling system of the luminosity detector

Heinrich Leithoff

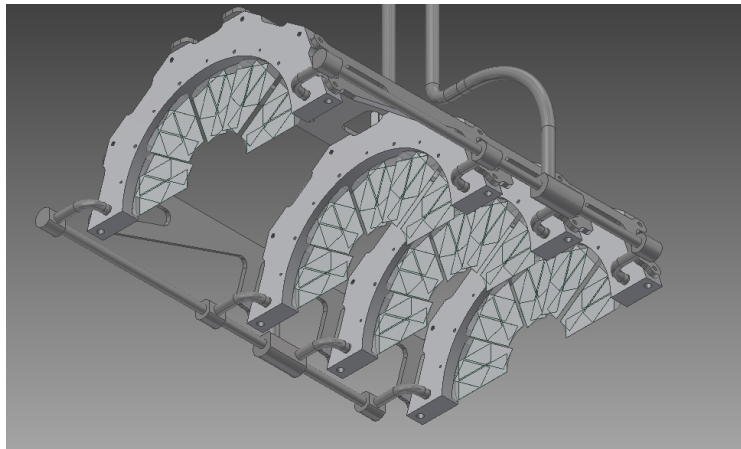
Helmholtz Institut Mainz

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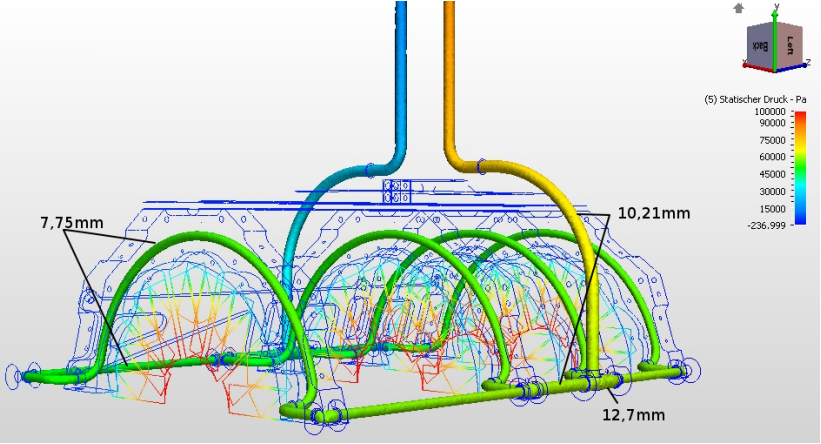
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# General setup



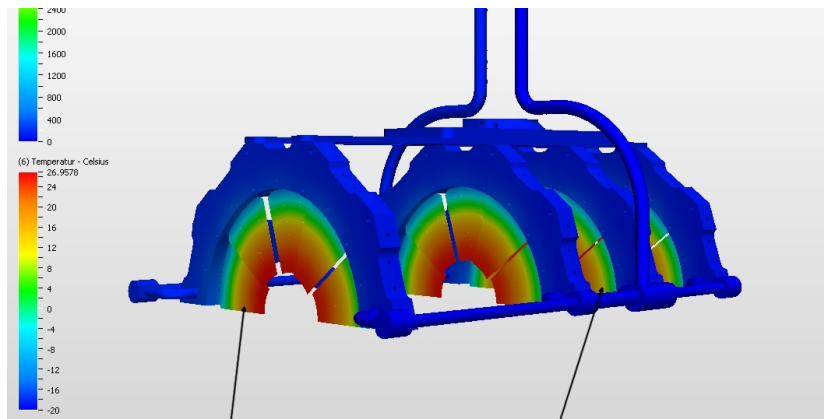
Estimated power consumption: Up to 1,12 kW

# Pressure distribution



1 bar at the inlet and 0 bar at the outlet applied  
No significant pressure drop expected

# Temperature distribution



warmest diamond

coldest diamond

$$\frac{T_{min}}{^{\circ}C}$$

-15,683

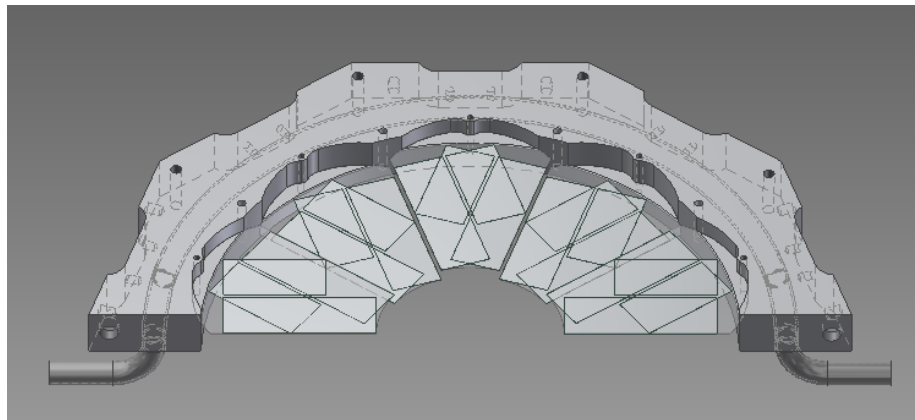
-17,155

$$\frac{T_{max}}{^{\circ}C}$$

26,955

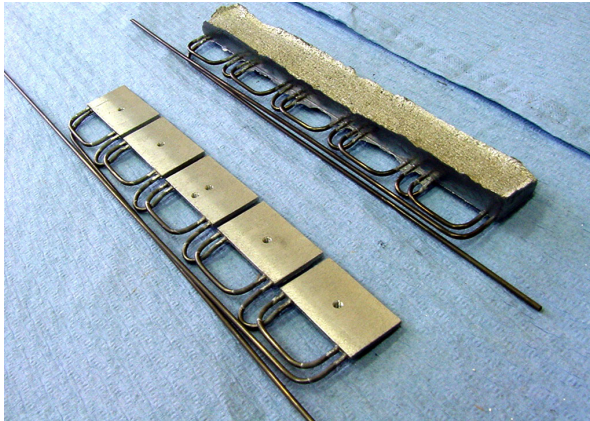
25,494

## Cooling support with sensors



- A good contact between cooling pipe and aluminium is needed
- Can we melt aluminium around a stainless steel pipe?

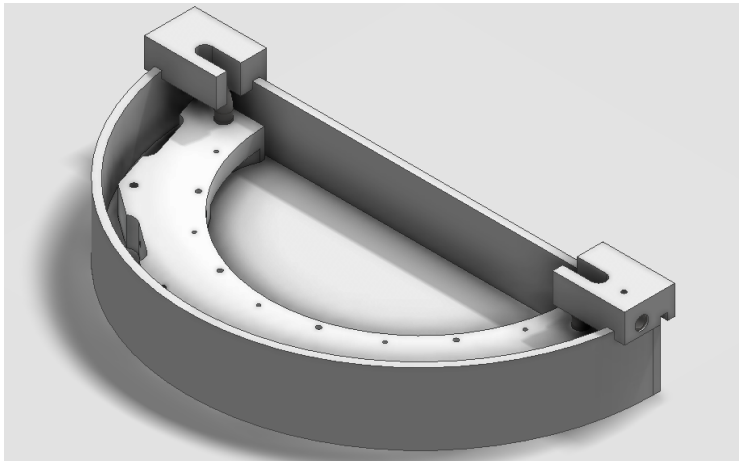
# Melting aluminium around stainless steel pipes



<http://www.nikhef.nl/pub/departments/mt/projects/lhcb-vertex/production/Coolingsystem/DSC05408.JPG>

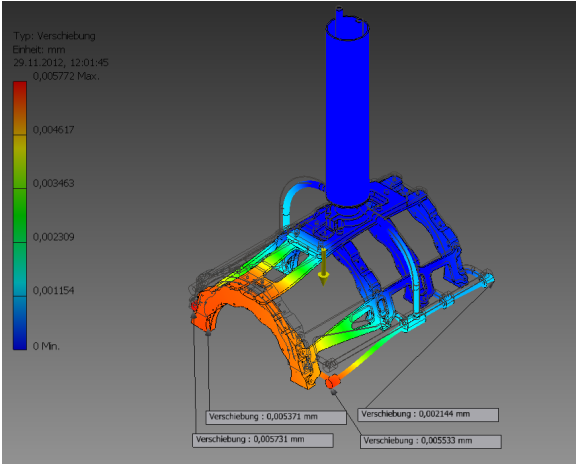
The VELO-detector used much smaller pipes ( $\varnothing$  1,5mm)

## Casting mould with cooling support



The pipe can move in one direction during the melting process  
First tests are planned to be made in Jülich end of January

# Mechanical Stability



Displacement by gravitation is small ( $< 10\%$  of pixel size)

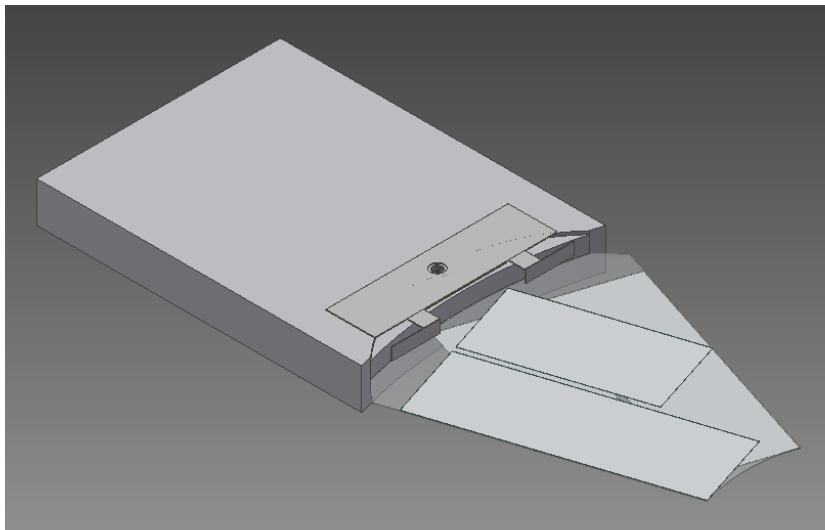


# Summary and outlook

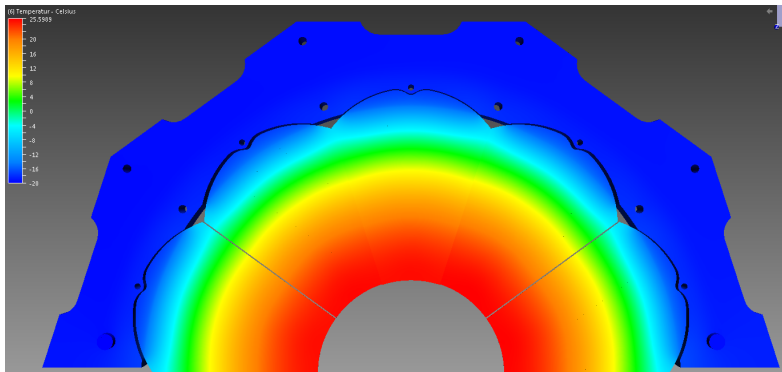
- Simulations of thermal behaviour are promising, but they need to be tested
- Current design has advantage of good thermal contact, but the production may be difficult

What is next:

- test the mounting of the diamond wafer on an aluminium block
- test the thermal behaviour of the diamond wafer
- melt aluminium around a pipe in the casting mould and find suitable process parameters

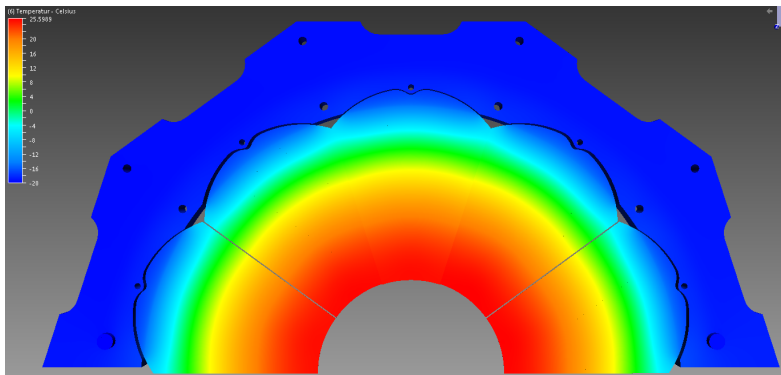


How many pipes do we need?



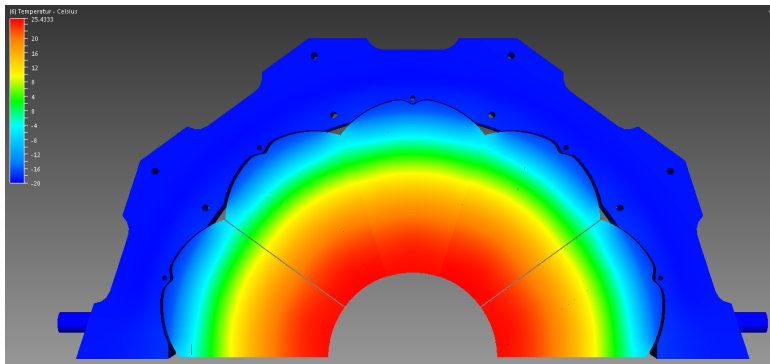
simulation with two pipes and opposite flow directions:

	warmest diamond	coldest diamond
$\frac{T_{min}}{^{\circ}C}$	-16,734	-17,193
$\frac{T_{max}}{^{\circ}C}$	25,882	25,566



simulation with two pipes and parallel flow directions:

	warmest diamond	coldest diamond
$\frac{T_{min}}{^{\circ}C}$	-16,989	-17,717
$\frac{T_{max}}{^{\circ}C}$	25,598	25,026



	warmest diamond	coldest diamond
$\frac{T_{min}}{^{\circ}C}$	-15,573	-17,139
$\frac{T_{max}}{^{\circ}C}$	26,998	25,139

Temperature gradient for 200  $\mu\text{m}$  diamond wafer is roughly  $40^{\circ}$  in the worst case